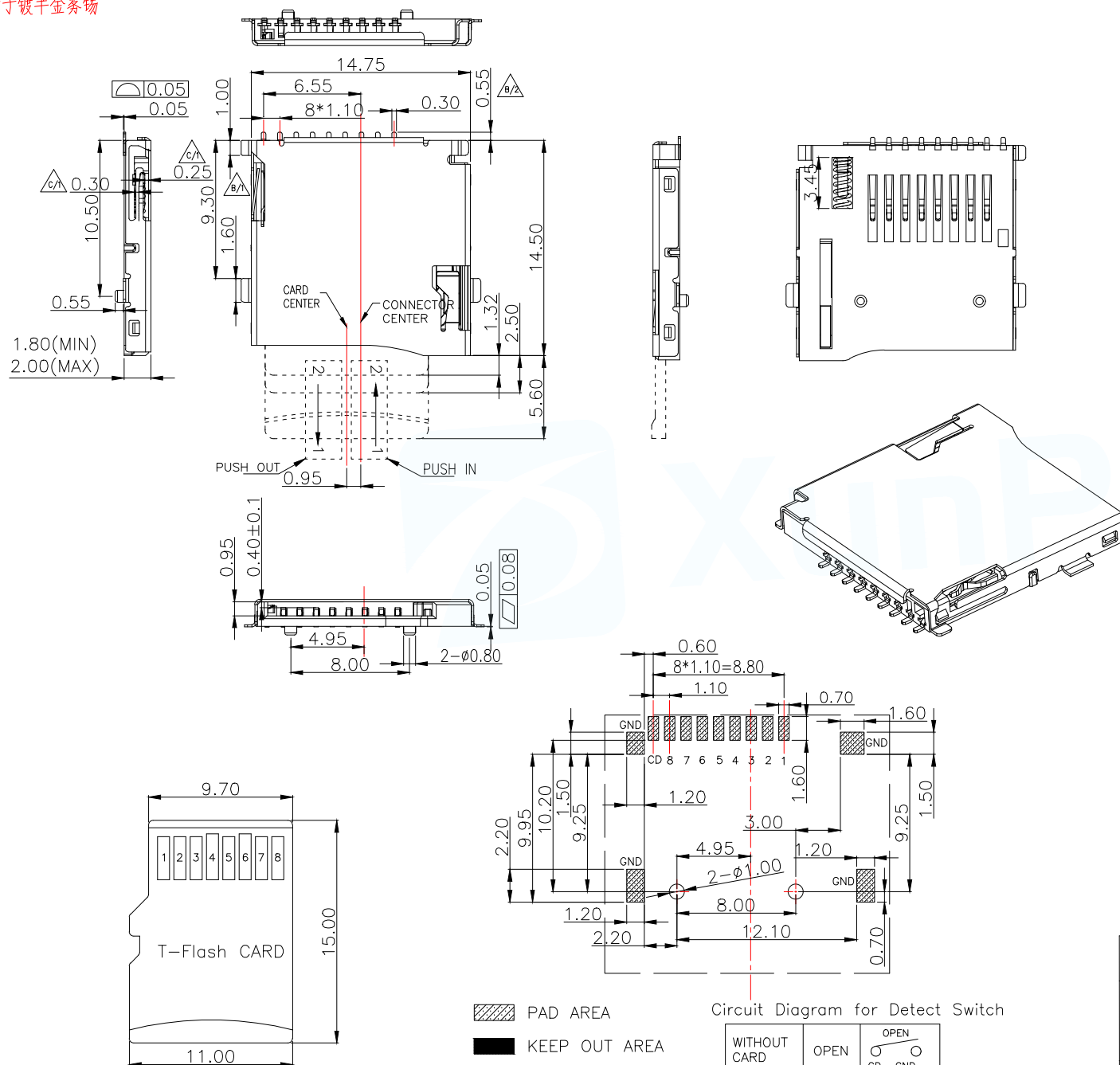


端子镀半金零锡



Specification:

1.Electrical Characteristics:

Contact Current Rating:0.5 Amperes.
Dielectric Withstanding Voltage:AC500V r.m.s.
Insulation Resistance:1000 MΩ Minimum.
Contact Resistance:40 mΩ Maximum.

2.Environmental:

Operating Temperature:-25°C~+90°C.

3.Environmental:

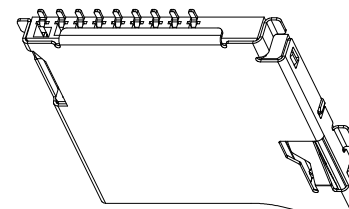
Mating Cycles:5,000 Insertions.

4.Mechanical Characteristics:

Card Push Insertion/Out Force:0.2~1.40kgf.
Contact Separation Force:0.20kgf Minimum.

5.Material:

Insulator:HI-Temp Plastic UL 94V-0 Rated.
Contact:Copper Alloy(t=0.15mm).
Shell:Stainless Steel(t=0.15mm).
Spring:SWP.



TF CARD PIN DEFINE

PIN NO.	NAME	YTYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)

MANUFACTURE DWG



东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co.,Ltd

UNLESS OTHERWISE
SPECIFIED TOLERANCESTITLE:MICRO SD CARD PUSH
PUSH SMT 不镀金 外牌

DECIMALS:

X.X:±0.35

X.XX:±0.25

X.XXX:±0.15

ANGLES:

X.X':±3°

X.XX':±2°

CUSTOMER COPY

PAR TF-115-BCP9

DWN

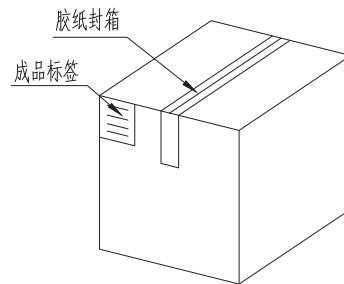
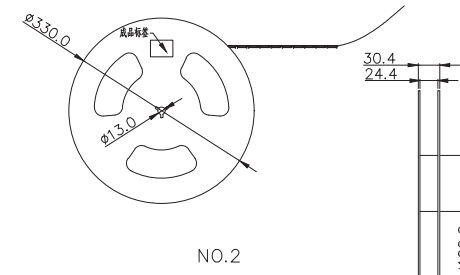
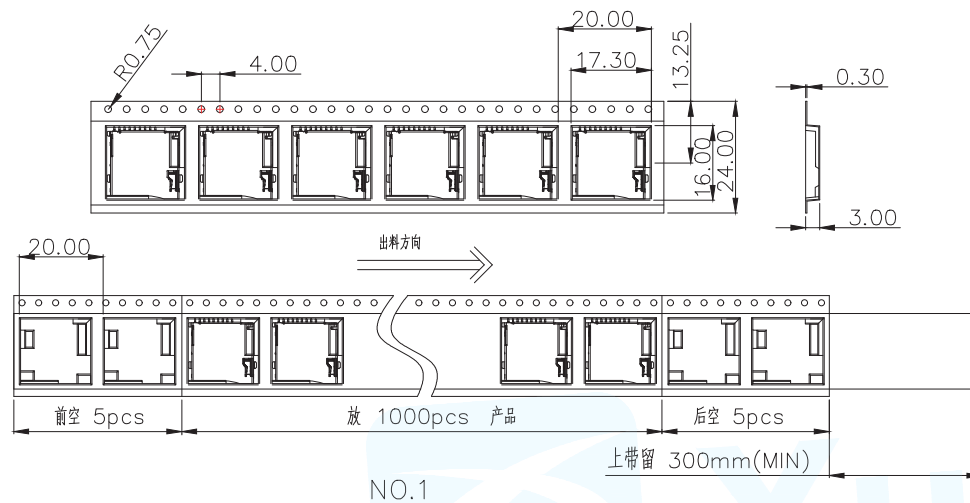
CHKD

APVD

SCALE:1:1 UNIT:MM

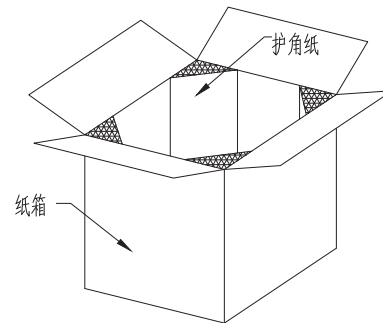
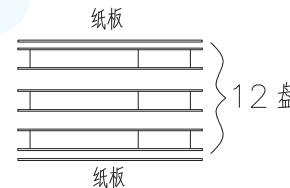
SIZE:A4 SHEET:1F1

REV:A



纸箱规格: 340*340*385

NO.4



NO.3

1. 材质要求:

- 1.1 纸箱的材质为K; 外形尺寸为34*34*38.5;
- 1.2 卷盘的材质为PS, 卷盘的外形尺寸为 $\phi 330 \times 30.4$;
- 1.3 卷带的材质为PS, 卷带的外形尺寸为20200*24.00*3.0mm;

2. 包装方式:

- 2.1 将卷带放入包装机后, 前空5PCS, 后放产品1000PCS, 再后空5PCS; 上带留300MM长度。
- 2.2 将包装好的产品从包装机上取下并包装好, 贴上内盘标签;
- 2.3 把累叠好的12盘叠放入纸箱中共计12Kset, 上下放纸板, 纸箱四个角塞护角纸;
- 2.4 把包装好的成品打包封箱, 并在纸箱外贴上标签

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: MICRO SD CARD PUSH PUSH SMT 不镀金 外焊	
			PAR	TF-115-BCP9
DECIMALS:	ANGLES:		DWN	
X.X: ±0.35	X.X": ±3°		CHKD	
X.XX: ±0.25	X.XX": ±2°		APVD	
X.XXX: ±0.15			SCALE: 1	UNIT: MM
CUSTOMER COPY		SIZE: A4	SHEET: 1F1	REV: A